IBM Unveils World's First 2 Nanometer Chip Technology, Opening a New Frontier for Semiconductors

New chip milestone to propel major leaps forward in performance and energy efficiency

ALBANY, N.Y., May 6, 2021 /PRNewswire/ -- IBM (NYSE: IBM) today unveiled a breakthrough in semiconductor design and process with the development of the world's first chip announced with 2 nanometer (nm) nanosheet technology. Semiconductors play critical roles in everything from computing, to appliances, to communication devices, transportation systems, and critical infrastructure.

"The IBM innovation reflected in this new 2 nm chip is essential to the entire semiconductor and IT industry," said Dario Gil, SVP and Director of IBM Research. "It is the product of IBM's approach of taking on hard tech challenges and a demonstration of how breakthroughs can result from sustained investments and a collaborative R&D ecosystem approach."

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The potential benefits of these advanced 2 nm chips could include:

- **Quadrupling cell phone battery life**, only requiring users to charge their devices every four days.
- **Slashing the carbon footprint of data centers**, which account for one percent of global energy use. Changing all of their servers to 2 nm-based processors could potentially reduce that number significantly.
- **Drastically speeding up a laptop's functions**, ranging from quicker processing in applications, to assisting in language translation more easily, to faster internet access.
- **Contributing to faster object detection** and reaction time in autonomous vehicles like self-driving cars.

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**IBM at the forefront of semiconductor innovation**

This latest breakthrough builds on decades of IBM leadership in semiconductor innovation. The company's semiconductor development efforts are based at its research lab located at the Albany Nanotech Complex in Albany, NY, where IBM scientists work in close collaboration with public and private sector partners to push the boundaries of logic scaling and semiconductor capabilities.

This collaborative approach to innovation makes IBM Research Albany a world-leading ecosystem for semiconductor research and creates a strong innovation pipeline, helping to address manufacturing demands and accelerate the growth of the global chip industry.

IBM's legacy of semiconductor breakthroughs also includes the first implementation of 7 nm and 5 nm process technologies, single cell DRAM, the Dennard Scaling Laws, chemically amplified photoresists, copper
interconnect wiring, Silicon on Insulator technology, multi core microprocessors, High-k gate dielectrics, embedded DRAM, and 3D chip stacking. IBM's first commercialized offering including IBM Research 7 nm advancements will debut later this year in IBM POWER10-based IBM Power Systems.

**50 billion transistors on a fingernail-sized chip**
Increasing the number of transistors per chip can make them smaller, faster, more reliable, and more efficient. The 2 nm design demonstrates the advanced scaling of semiconductors using IBM's nanosheet technology. Its architecture is an industry first. Developed less than four years after IBM announced its milestone 5 nm design, this latest breakthrough will allow the 2 nm chip to fit up to 50 billion transistors on a chip the size of a fingernail.

More transistors on a chip also means processor designers have more options to infuse core-level innovations to improve capabilities for leading edge workloads like AI and cloud computing, as well as new pathways for hardware-enforced security and encryption. IBM is already implementing other innovative core-level enhancements in the latest generations of IBM hardware, like IBM POWER10 and IBM z15.

**About IBM**
IBM is a leading global hybrid cloud and AI, and business services provider, helping clients in more than 175 countries capitalize on insights from their data, streamline business processes, reduce costs and gain the competitive edge in their industries. Nearly 3,000 government and corporate entities in critical infrastructure areas such as financial services, telecommunications and healthcare rely on IBM's hybrid cloud platform and Red Hat OpenShift to affect their digital transformations quickly, efficiently, and securely. IBM's breakthrough innovations in AI, quantum computing, industry-specific cloud solutions and business services deliver open and flexible options to our clients. All of this is backed by IBM's legendary commitment to trust, transparency, responsibility, inclusivity, and service.

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i Based on the projected industry standard scaling roadmap

ii Based on current usage statistics for 7 nm-based cell phones

iii [https://science.sciencemag.org/content/367/6481/984](https://science.sciencemag.org/content/367/6481/984)

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